### TOSHIBA PHOTOCOUPLER PHOTO RELAY

# **TLP3131**

MEASUREMENT INSTRUMENTS LOGIC IC TESTERS / MEMORY TESTERS BOARD TESTERS / SCANNERS

The TOSHIBA TLP3131 Mini-flat photorelay is a small-outline photorelay, suitable for surface-mount assembly. The TLP3131 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

The TLP3131 features low CR product and especially low ON-state resistance, allowing high ON-state current.

Its characteristics also include low OFF-state current and low output pin capacitance, enabling it to be used in high-frequency measuring instruments.

### **Features**

• 4 pin SOP (2.54SOP4) : 2.1 mm high, 2.54 mm pitch

• 1-Form-A

Peak Off-State Voltage : 20 V (min)
 Trigger LED Current : 4 mA (max)
 On-State Current : 300 mA (max)

• On-State Resistance :  $1.5 \Omega$  (max),  $1.0 \Omega$  (typ.) • Output Capacitance : 12.0 pF (max), 5.0 pF (typ.)

• Isolation Voltage : 1500 Vrms (min)

• UL approved: UL1577, File No.E67349

• cUL approved :CSA Component Acceptance Service

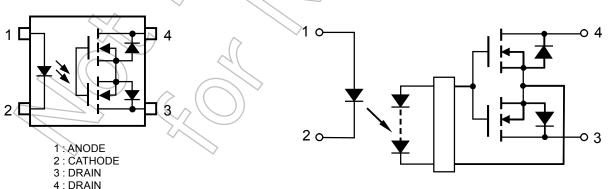
No. 5A, File No.E67349

# JEDEC — JEITA — TOSHIBA 11–5H1

Weight: 0.1 g (typ.)

# Pin Configuration (top view)

### Schematic



Start of commercial production 2001-03

### Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current	lF	50	mA
	Forward Current Derating (Ta ≥ 25°C)	ΔI <sub>F</sub> /°C	-0.5	mA/°C
٥	Reverse Voltage	V <sub>R</sub>	5	V
LED	Diode Power Dissipation	P <sub>D</sub>	50	mW
	Diode Power Dissipation Derating (Ta ≥ 25°C)	ΔP <sub>D</sub> /°C	-0.5	mW/°C
	Junction Temperature	Tj	125	°C
	Off-State Output Terminal Voltage	V <sub>OFF</sub>	20	( <del>V</del> 7)
DETECTOR	On-State Current	I <sub>ON</sub>	300	mA
	On-State Current Derating (Ta ≥ 25°C)	ΔI <sub>ON</sub> /°C	-3.0	mA/°C
	Output Power Dissipation	Po	135	mW
	Output Power Dissipation Derating (Ta ≥ 25°C)	ΔP <sub>o</sub> /°C	-1.35	mW / °C
	Junction Temperature	Tj	125	°C
Storage Temperature Range		T <sub>stg</sub>	-40 to 125	°C
Operating Temperature Range		T <sub>opr</sub>	-20 to 85	°C>
Lead	Soldering Temperature (10 s)	T <sub>sol</sub>	260	°C <
Isolat	tion Voltage (AC, 1 minute, R.H. ≤ 60%) (Note 1)	BVs	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device. Pins 1 and 2 shorted together, and pins 3 and 4 shorted together.

### Caution

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

### **Recommended Operating Conditions**

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage	$V_{DD}$	>-	_	20	V
Forward Current	)F	10	_	30	mA
On-State Current	ION	_	_	300	mA
Operating Temperature	T <sub>opr</sub>	25	_	60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

### Individual Electrical Characteristics (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
	Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
ED	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μА
	Capacitance between terminals	C <sub>T</sub>	V <sub>F</sub> = 0 V, f = 1 MHz	_	15	_	pF
DETECTOR	Off-State Current	loff	V <sub>OFF</sub> = 20 V, Ta = 50°C	_	_	1000	pA
	Capacitance between terminals	C <sub>OFF</sub>	V = 0 V, f = 100 MHz, t < 1 s	_	5.0	12.0	pF

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# **Coupled Electrical Characteristics (Ta = 25°C)**

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Trigger LED Current	I <sub>FT</sub>	I <sub>ON</sub> = 100 mA	_	_	4	mA
Return LED Current	I <sub>FC</sub>	I <sub>OFF</sub> = 10 μA	0.2	0.75	_	mA
On-State Resistance	R <sub>ON</sub>	$I_{ON} = 300 \text{ mA}, I_F = 5 \text{ mA}, t < 1 \text{ s}$	4	1	1.5	Ω

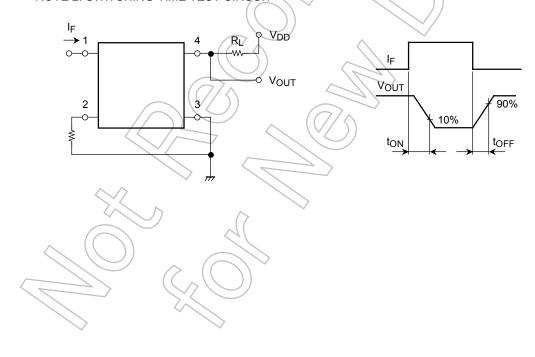
## **Isolation Characteristics (Ta = 25°C)**

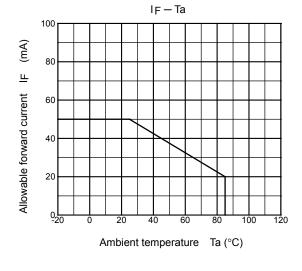
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Capacitance Input to Output	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	<u></u>	0.8	_	pF
Isolation Resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≤ 60%	5 × 10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
		AC, 1 minute	1500	-(		Vrms
Isolation Voltage	$BV_S$	AC, 1 second (in oil)	_	3000		VIIIIS
		DC, 1 minute (in oil)	_	3000	<u> </u>	Vdc

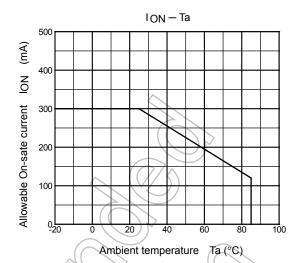
# **Switching Characteristics (Ta = 25°C)**

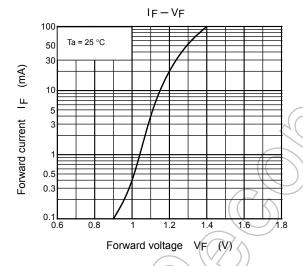
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Turn-on Time	t <sub>ON</sub>	$R_L = 200 \Omega$ (NOTE 2)	7/A	_	500	0
Turn-off Time	toff	$V_{DD} = 10 \text{ V, I}_{F} = 10 \text{ mA}$	$\mathcal{L}$	_	500	μS

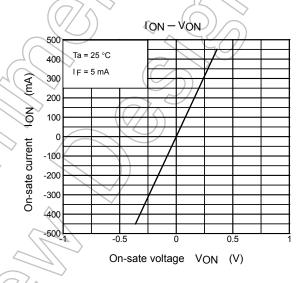
NOTE 2: SWITCHING TIME TEST CIRCUIT

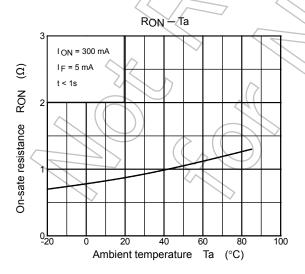


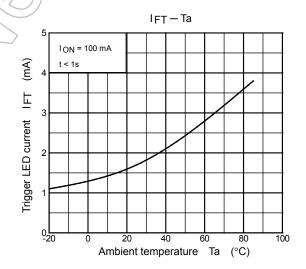


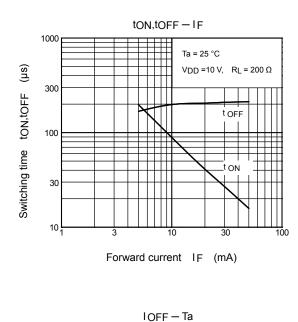


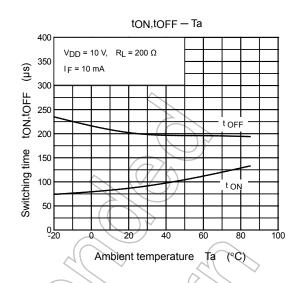


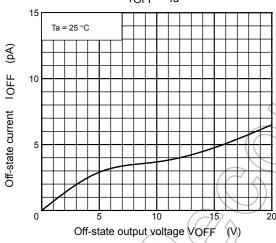


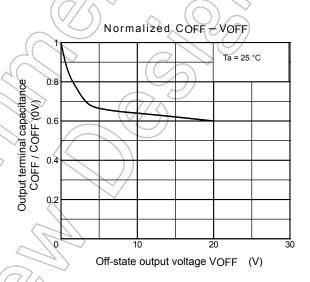












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